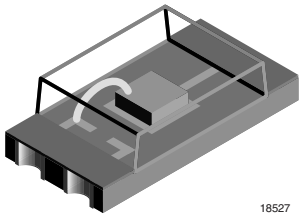
Ambient Light Sensor



FEATURES

- Package type: surface mount
- Package form: 1206
- Dimensions (L x W x H in mm): 4 x 2 x 1.05
- AEC-Q101 qualified
- High photo sensitivity
- Adapted to human eye responsivity
- Angle of half sensitivity: φ = ± 60°
- Floor life: 168 h, MSL 3, acc. J-STD-020
- Lead (Pb)-free reflow soldering
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

AUTOMOTIVE GRADE

Pb-free

e4

RoHS COMPLIANT

GREEN (5-2008)**

Note

** Please see document “Vishay Material Category Policy”: www.vishay.com/doc?99902

DESCRIPTION

TEMT6000X01 ambient light sensor is a silicon NPN epitaxial planar phototransistor in a miniature transparent 1206 package for surface mounting. It is sensitive to visible light much like the human eye and has peak sensitivity at 570 nm.

APPLICATIONS

Ambient light sensor for control of display backlight dimming in LCD displays and keypad backlighting of mobile devices and in industrial on/off-lighting operation.

- Automotive sensors
- Mobile phones
- Notebook computers
- PDA’s
- Cameras
- Dashboards

PRODUCT SUMMARY			
COMPONENT	I_{PCE} (µA)	φ (deg)	$\lambda_{0.5}$ (nm)
TEMT6000X01	50	± 60	440 to 800

Note

- Test condition see table “Basic Characteristics”

ORDERING INFORMATION			
ORDERING CODE	PACKAGING	REMARKS	PACKAGE FORM
TEMT6000X01	Tape and reel	MOQ: 3000 pcs, 3000 pcs/reel	1206

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Collector emitter voltage		V_{CEO}	6	V
Emitter collector voltage		V_{ECO}	1.5	V
Collector current		I_C	20	mA
Power dissipation		P_V	100	mW

ABSOLUTE MAXIMUM RATINGS (T_{amb} = 25 °C, unless otherwise specified)				
PARAMETER	**TEST CONDITION**	**SYMBOL**	**VALUE**	**UNIT**
Junction temperature		T_j	100	°C
Operating temperature range		T_{amb}	- 40 to + 100	°C
Storage temperature range		T_{stg}	- 40 to + 100	°C
Soldering temperature	Acc. reflow solder profile fig. 8	T_{sd}	260	°C
Thermal resistance junction/ambient	Soldered on PCB with pad dimensions: 4 mm x 4 mm	R_{thJA}	450	K/W

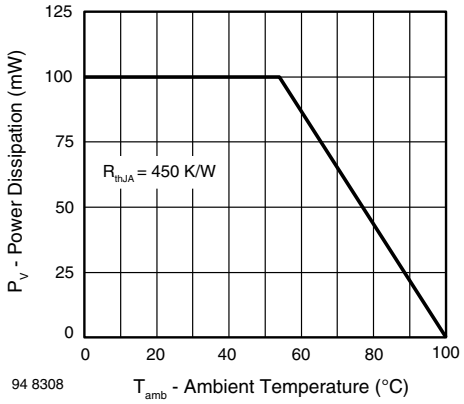


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)						
PARAMETER	**TEST CONDITION**	**SYMBOL**	**MIN.**	**TYP.**	**MAX.**	**UNIT**
Collector emitter breakdown voltage	I_C = 0.1 mA	V_{CEO}	6			V
Collector dark current	V_{CE} = 5 V, E = 0	I_{CEO}		3	50	nA
Collector emitter capacitance	V_{CE} = 0 V, f = 1 MHz, E = 0	C_{CEO}		16		pF
Collector light current	E_V = 20 lx, CIE illuminant A, V_{CE} = 5 V	I_{PCE}	3.5	10	16	µA
	E_V = 100 lx, CIE illuminant A, V_{CE} = 5 V	I_{PCE}		50		µA
Temperature coefficient of I_{PCE}	CIE illuminant A	TK_{IPCE}		1.18		%/K
	LED, white	TK_{IPCE}		0.9		%/K
Angle of half sensitivity		φ		± 60		deg
Wavelength of peak sensitivity		λ_p		570		nm
Range of spectral bandwidth		$\lambda_{0.5}$		440 to 800		nm
Collector emitter saturation voltage	E_V = 20 lx, CIE illuminant A, I_{PCE} = 1.2 µA	V_{CEsat}		0.1		V

BASIC CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

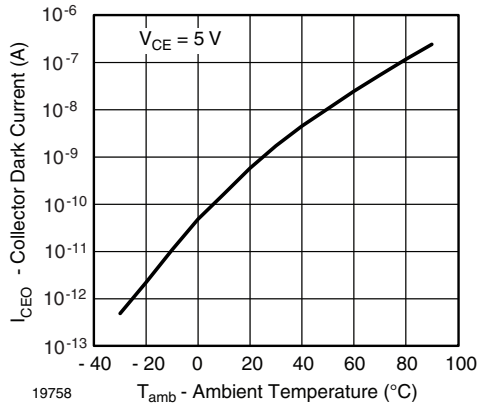


Fig. 1 - Collector Dark Current vs. Ambient Temperature

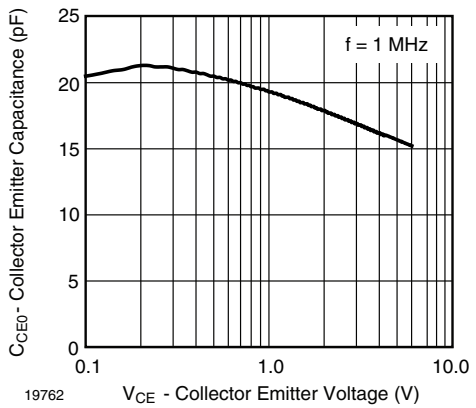


Fig. 4 - Collector Emitter Capacitance vs. Collector Emitter Voltage

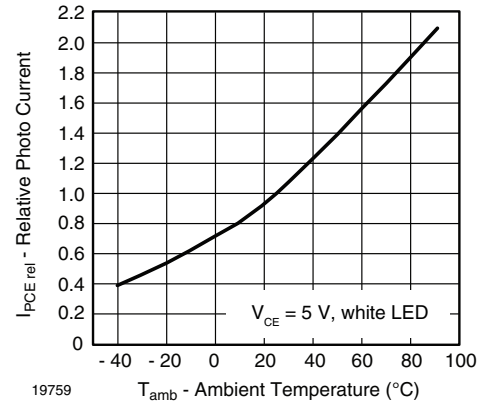


Fig. 2 - Relative Photo Current vs. Ambient Temperature

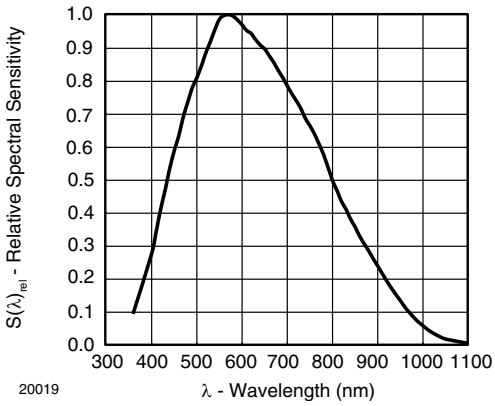


Fig. 5 - Relative Spectral Sensitivity vs. Wavelength

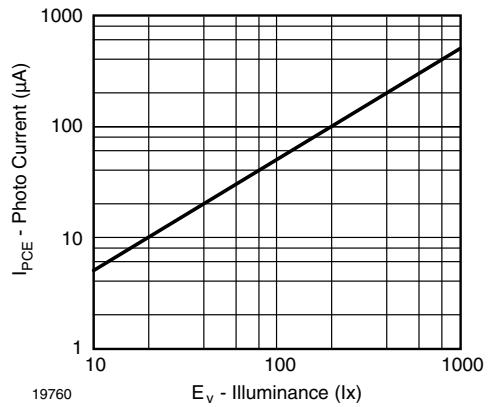


Fig. 3 - Photo Current vs. Illuminance

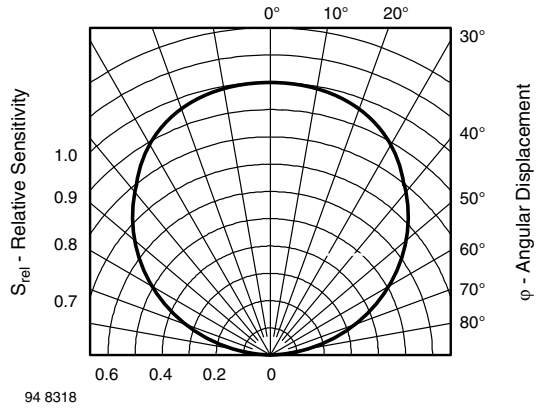


Fig. 6 - Relative Radiant Sensitivity vs. Angular Displacement

REFLOW SOLDER PROFILE

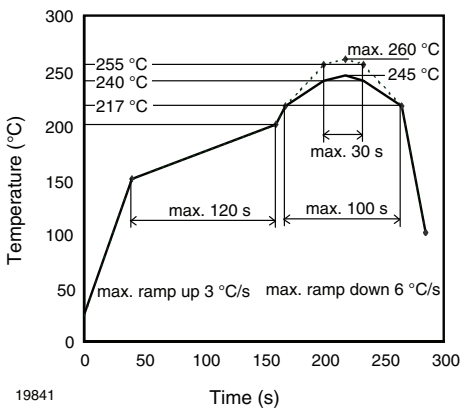


Fig. 7 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020D

DRYPACK

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

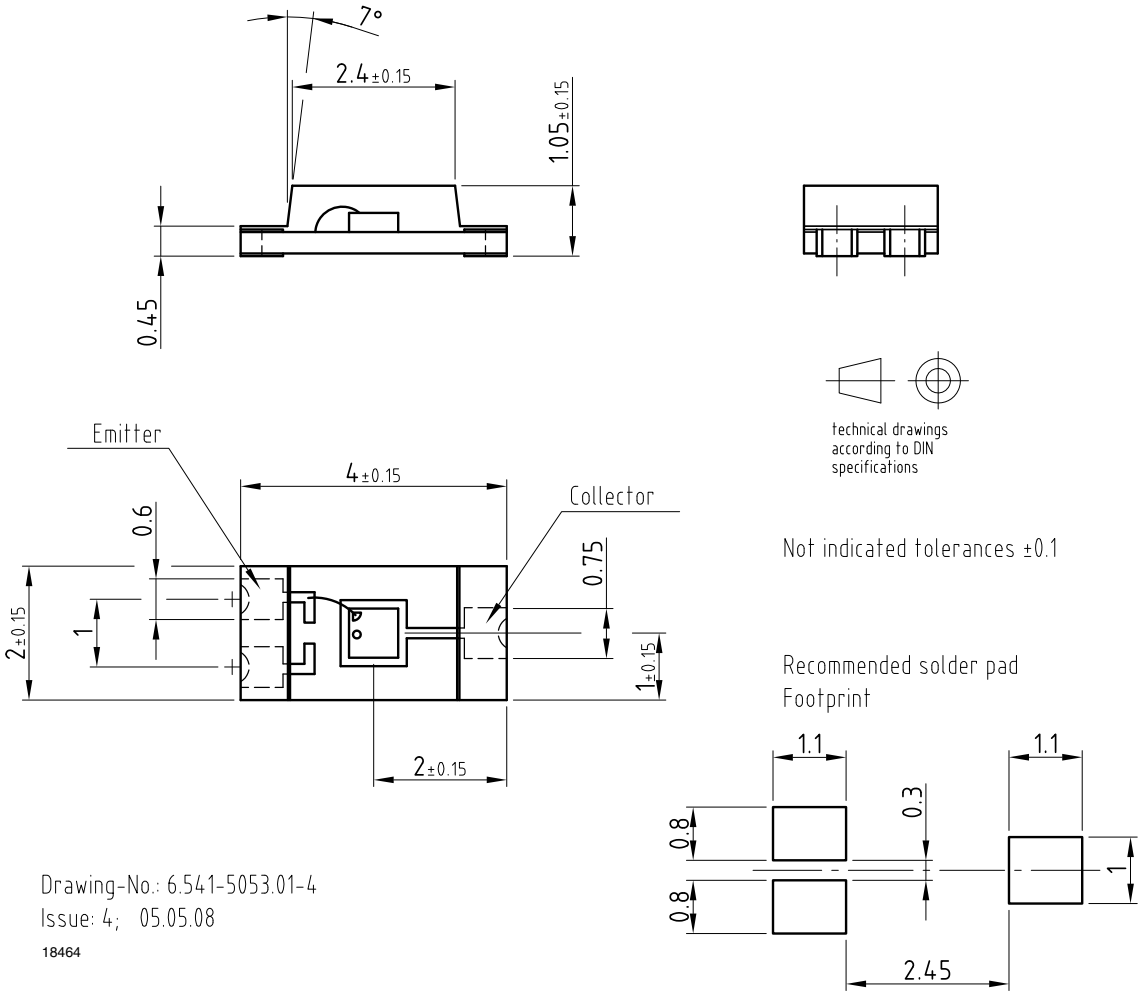
FLOOR LIFE

Time between soldering and removing from MBB must not exceed the time indicated in J-STD-020:
Moisture sensitivity: level 3
Floor life: 168 h
Conditions: T_{amb} < 30 °C, RH < 60 %

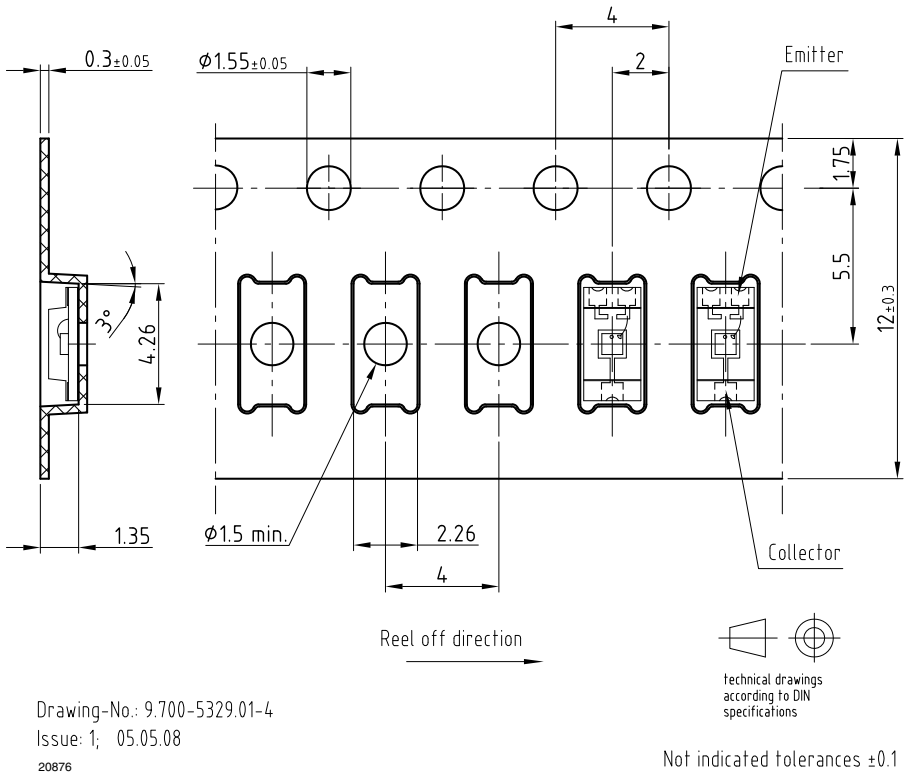
DRYING

In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions:
192 h at 40 °C (+ 5 °C), RH < 5 %
or
96 h at 60 °C (+ 5 °C), RH < 5 %.

PACKAGE DIMENSIONS in millimeters



BLISTER TAPE DIMENSIONS in millimeters

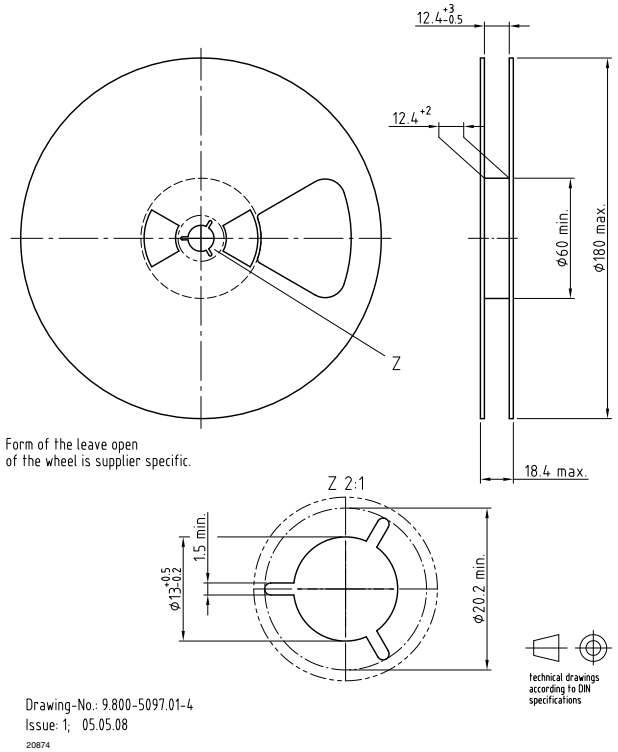


Drawing-No.: 9.700-5329.01-4
Issue: 1; 05.05.08
20876

Not indicated tolerances ±0.1

REEL DIMENSIONS in millimeters

Volume: 3000 pcs/reel



Drawing-No.: 9.800-5097.01-4
Issue: 1; 05.05.08
20874

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